BC807; BC807W; BC327 45 V, 500 mA PNP general-purpose transistors Rev. 06 — 17 November 2009

Product data sheet

Product profile

1.1 General description

PNP general-purpose transistors.

Table 1. **Product overview**

| Type number | Package | | NPN complement | |
|-------------|---------------|--------|----------------|--|
| | NXP | JEITA | _ | |
| BC807 | SOT23 | - | BC817 | |
| BC807W | SOT323 | SC-70 | BC817W | |
| BC327[1] | SOT54 (TO-92) | SC-43A | BC337 | |

^[1] Also available in SOT54A and SOT54 variant packages (see Section 2).

1.2 Features

- High current
- Low voltage

1.3 Applications

■ General-purpose switching and amplification

1.4 Quick reference data

Table 2. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------|-------------------------------|---|-----|-----|-----|------------|------|
| V_{CEO} | collector-emitter voltage | open base; I _C = 10 mA | | - | - | -45 | V |
| I _C | collector current (DC) | | | - | - | -500 | mΑ |
| I _{CM} | peak collector current | | | - | - | -1 | Α |
| h _{FE} | DC current gain | $I_C = -100 \text{ mA};$ $V_{CE} = -1 \text{ V}$ | [1] | | | | |
| | BC807; BC807W; BC327 | | | 100 | - | 600 | |
| | BC807-16; BC807-16W; BC327-16 | | | 100 | - | 250 | |
| | BC807-25; BC807-25W; BC327-25 | | | 160 | - | 400 | |
| | BC807-40; BC807-40W; BC327-40 | | | 250 | - | 600 | |

^[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$



2. Pinning information

| Table 3. | Pinning | | |
|----------|-------------|--------------------|----------------|
| Pin | Description | Simplified outline | Symbol |
| SOT23 | | | |
| 1 | base | _ | |
| 2 | emitter | 3 | 3 |
| 3 | collector | | 1 — |
| | | 1 2 | 2 |
| | | | sym013 |
| SOT323 | | | |
| 1 | base | | |
| 2 | emitter | 3 | 3 |
| 3 | collector | | 1 — |
| | | | '`` |
| | | | 2 |
| | | 1 2 | sym013 |
| | | sot323_so | |
| SOT54 | | | |
| 1 | emitter | | 2 |
| 2 | base | | 3 |
| 3 | collector | | 2 — |
| | | | .] |
| | | 001aab347 | 1 006aaa149 |
| SOT54A | | | 000aa149 |
| 1 | emitter | | |
| 2 | base | | 3 |
| 3 | collector | | |
| 3 | Collector | | 2 — |
| | | 001aab348 | 1 |
| | | 0018d0346 | 006aaa149 |
| SOT54 va | riant | | |
| 1 | emitter | | |
| 2 | base | V 2 | 3 |
| 3 | collector | | 2 |
| | | 0 B 2 3 | 18 |
| | | 001aab447 | 1 |
| | | | 006aaa149 |

3. Ordering information

Table 4. Ordering information

| Type number[1] | Package | Package | | |
|----------------|---------|---|---------|--|
| | Name | Description | Version | |
| BC807 | - | plastic surface mounted package; 3 leads | SOT23 | |
| BC807W | SC-70 | plastic surface mounted package; 3 leads | SOT323 | |
| BC327[2] | SC-43A | plastic single-ended leaded (through hole) package; 3 leads | SOT54 | |

^[1] Valid for all available selection groups.

4. Marking

Table 5. Marking codes

| Table 3. Marking codes | |
|------------------------|-----------------------------|
| Type number | Marking code ^[1] |
| BC807 | 5D* |
| BC807-16 | 5A* |
| BC807-25 | 5B* |
| BC807-40 | 5C* |
| BC807W | 5D* |
| BC807-16W | 5A* |
| BC807-25W | 5B* |
| BC807-40W | 5C* |
| BC327 | C327 |
| BC327-16 | C32716 |
| BC327-25 | C32725 |
| BC327-40 | C32740 |
| | |

^{[1] * = -:} made in Hong Kong

^[2] Also available in SOT54A and SOT54 variant packages (see Section 2 and Section 9).

^{* =} p: made in Hong Kong

^{* =} t: made in Malaysia

^{* =} W: made in China

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------------|--------------------------------------|--------|------------|------|
| V_{CBO} | collector-base voltage | open emitter | - | -50 | V |
| V_{CEO} | collector-emitter voltage | open base; I _C = 10 mA | - | –45 | V |
| V_{EBO} | emitter-base voltage | open collector | - | -5 | V |
| I _C | collector current (DC) | | - | -500 | mA |
| I _{CM} | peak collector current | | - | -1 | Α |
| I _{BM} | peak base current | | - | -200 | mΑ |
| P _{tot} | total power dissipation | | | | |
| | BC807 | $T_{amb} \le 25 ^{\circ}C$ | [1][2] | 250 | mW |
| | BC807W | $T_{amb} \le 25 ^{\circ}C$ | [1][2] | 200 | mW |
| | BC327 | $T_{amb} \le 25 ^{\circ}C$ | [1][2] | 625 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | ambient temperature | | -65 | +150 | °C |

^[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 7. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------|---|-----------------------------|--------|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | | | | | |
| | BC807 | $T_{amb} \le 25 ^{\circ}C$ | [1][2] | - | 500 | K/W |
| | BC807W | $T_{amb} \le 25 ^{\circ}C$ | [1][2] | - | 625 | K/W |
| | BC327 | $T_{amb} \le 25 ^{\circ}C$ | [1][2] | - | 200 | K/W |

^[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

^[2] Valid for all available selection groups.

^[2] Valid for all available selection groups.

7. Characteristics

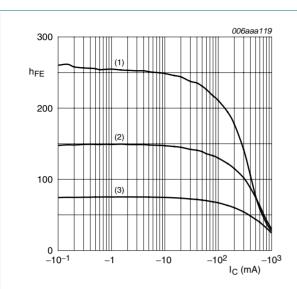
Table 8. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|--------------------------------------|--|---------------|-----|-----------|------|
| I _{CBO} | collector-base cut-off current | $I_E = 0 \text{ A}; V_{CB} = -20 \text{ V}$ | - | - | -100 | nA |
| | | $I_E = 0 \text{ A}; V_{CB} = -20 \text{ V};$ $T_j = 150 \text{ °C}$ | - | - | -5 | μΑ |
| I _{EBO} | emitter-base cut-off current | $I_C = 0 A; V_{EB} = -5 V$ | - | - | -100 | nA |
| h _{FE} | DC current gain | $I_C = -100 \text{ mA}; V_{CE} = -1 \text{ V}$ | <u>[1]</u> | | | |
| | BC807; BC807W; BC327 | | 100 | - | 600 | |
| | BC807-16; BC807-16W; BC327-16 | | 100 | - | 250 | |
| | BC807-25; BC807-25W; BC327-25 | | 160 | - | 400 | |
| | BC807-40; BC807-40W; BC327-40 | | 250 | - | 600 | |
| h _{FE} | DC current gain | $I_C = -500 \text{ mA}; V_{CE} = -1 \text{ V}$ | <u>[1]</u> 40 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | $I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$ | <u>[1]</u> - | - | -700 | mV |
| V_{BE} | base-emitter voltage | $I_C = -500 \text{ mA}; V_{CE} = -1 \text{ V}$ | [2] _ | - | -1.2 | V |
| C _c | collector capacitance | $I_E = i_e = 0 \text{ A}; V_{CB} = -10 \text{ V};$ f = 1 MHz | - | 5 | - | pF |
| f _T | transition frequency | $I_C = -10 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz | 80 | - | - | MHz |
| | | 1 = 100 111112 | | | | |

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

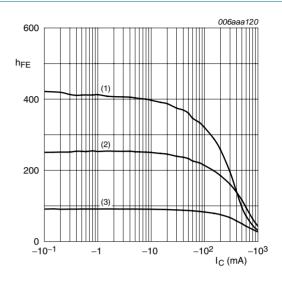
^[2] V_{BE} decreases by approximately 2 mV/K with increasing temperature.



$$V_{CE} = -1 V$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \,^{\circ}C$

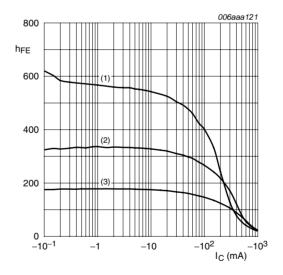
Fig 1. Selection -16: DC current gain as a function of collector current; typical values



$$V_{CE} = -1 V$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

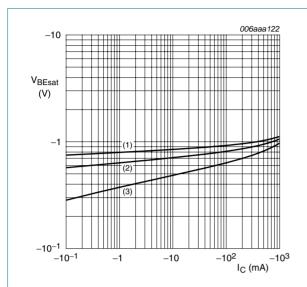
Fig 2. Selection -25: DC current gain as a function of collector current; typical values



$$V_{CE} = -1 V$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

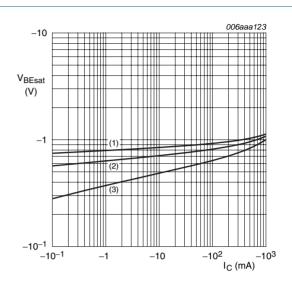
Fig 3. Selection -40: DC current gain as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

- (1) $T_{amb} = -55 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

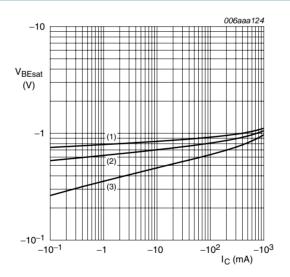
Fig 4. Selection -16: Base-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

- (1) $T_{amb} = -55 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

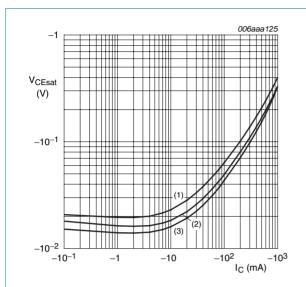
Fig 5. Selection -25: Base-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

- (1) $T_{amb} = -55 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

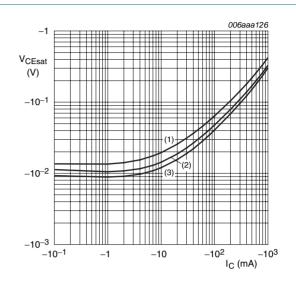
Fig 6. Selection -40: Base-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

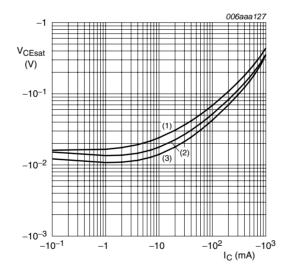
Fig 7. Selection -16: Collector-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

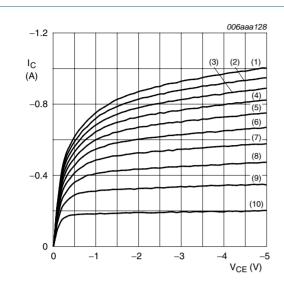
Fig 8. Selection- 25: Collector-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

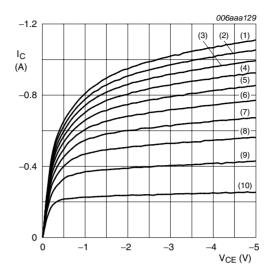
Fig 9. Selection -40: Collector-emitter saturation voltage as a function of collector current; typical values



 $T_{amb} = 25 \, ^{\circ}C$

- (1) $I_B = -16.0 \text{ mA}$
- (2) $I_B = -14.4 \text{ mA}$
- (3) $I_B = -12.8 \text{ mA}$
- (4) $I_B = -11.2 \text{ mA}$
- (5) $I_B = -9.6 \text{ mA}$
- (6) $I_B = -8.0 \text{ mA}$
- (7) $I_B = -6.4 \text{ mA}$
- (8) $I_B = -4.8 \text{ mA}$
- (9) $I_B = -3.2 \text{ mA}$
- (10) $I_B = -1.6 \text{ mA}$

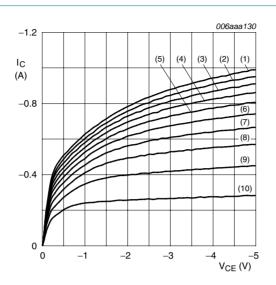
Fig 10. Selection -16: Collector current as a function of collector-emitter voltage; typical values



T_{amb} = 25 °C

- (1) $I_B = -13.0 \text{ mA}$
- (2) $I_B = -11.7 \text{ mA}$
- (3) $I_B = -10.4 \text{ mA}$
- (4) $I_B = -9.1 \text{ mA}$
- (5) $I_B = -7.8 \text{ mA}$
- (6) $I_B = -6.5 \text{ mA}$
- (7) $I_B = -5.2 \text{ mA}$
- (8) $I_B = -3.9 \text{ mA}$
- (9) $I_B = -2.6 \text{ mA}$
- (10) $I_B = -1.3 \text{ mA}$

Fig 11. Selection -25: Collector current as a function of collector-emitter voltage; typical values



 $T_{amb} = 25 \, ^{\circ}C$

- (1) $I_B = -12.0 \text{ mA}$
- (2) $I_B = -10.8 \text{ mA}$
- (3) $I_B = -9.6 \text{ mA}$
- (4) $I_B = -8.4 \text{ mA}$
- (5) $I_B = -7.2 \text{ mA}$
- (6) $I_B = -6.0 \text{ mA}$
- (7) $I_B = -4.8 \text{ mA}$
- (8) $I_B = -3.6 \text{ mA}$
- (9) $I_B = -2.4 \text{ mA}$
- (10) $I_B = -1.2 \text{ mA}$

Fig 12. Selection -40: Collector current as a function of collector-emitter voltage; typical values

8. Package outline

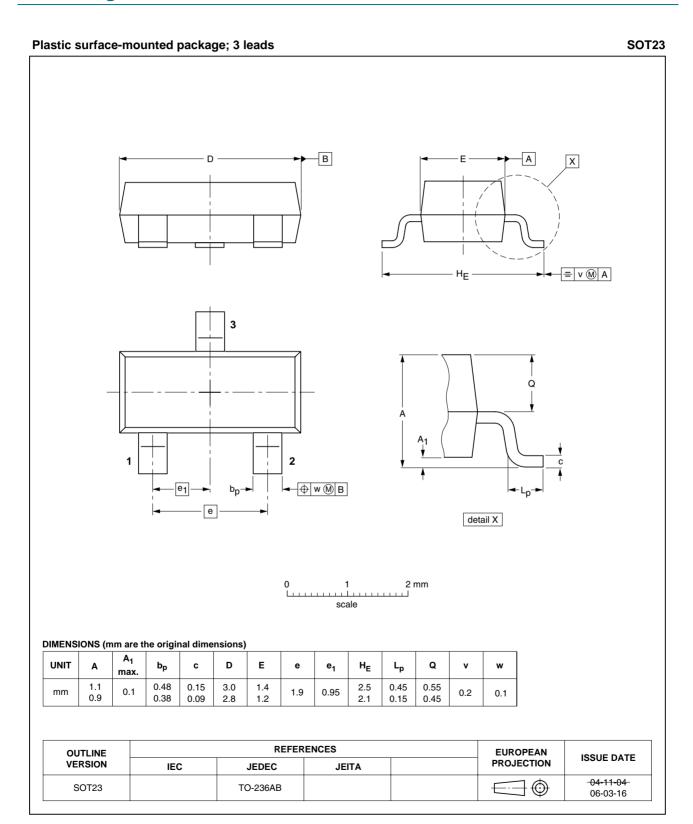


Fig 13. Package outline SOT23 (TO-236AB)

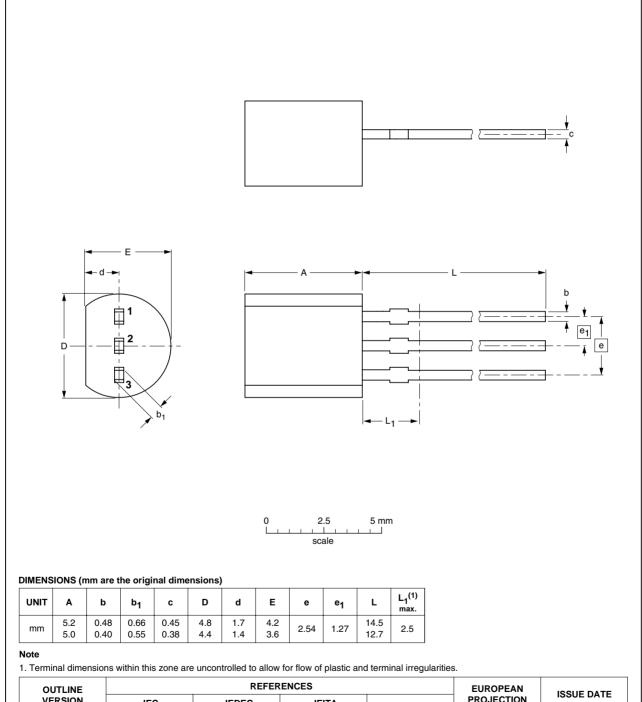
Plastic surface-mounted package; 3 leads **SOT323** В Α X = v M A H_{E} Q **→** | w (M) B е detail X 2 mm scale DIMENSIONS (mm are the original dimensions) UNIT D Ε Q bp С e₁ HΕ $L_{\mathbf{p}}$ w max 0.25 2.2 1.35 0.23 0.1 1.3 0.65 0.2 0.2 mm 0.8 0.3 0.10 1.15 REFERENCES **EUROPEAN** OUTLINE **ISSUE DATE** PROJECTION VERSION IEC **JEDEC JEITA** 04-11-04 SOT323 SC-70

Fig 14. Package outline SOT323 (SC-70)

06-03-16

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



| OUTLINE | | REFER | ENCES | EUROPEAN ISSUE DATE | | |
|---------|-----|-------|--------|---------------------|----------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | ISSUE DATE | |
| SOT54 | | TO-92 | SC-43A | | -04-06-28 04-11-16 | |

Fig 15. Package outline SOT54 (SC-43A/TO-92)

BC807_BC807W_BC327_6

Plastic single-ended leaded (through hole) package; 3 leads (wide pitch)

SOT54A

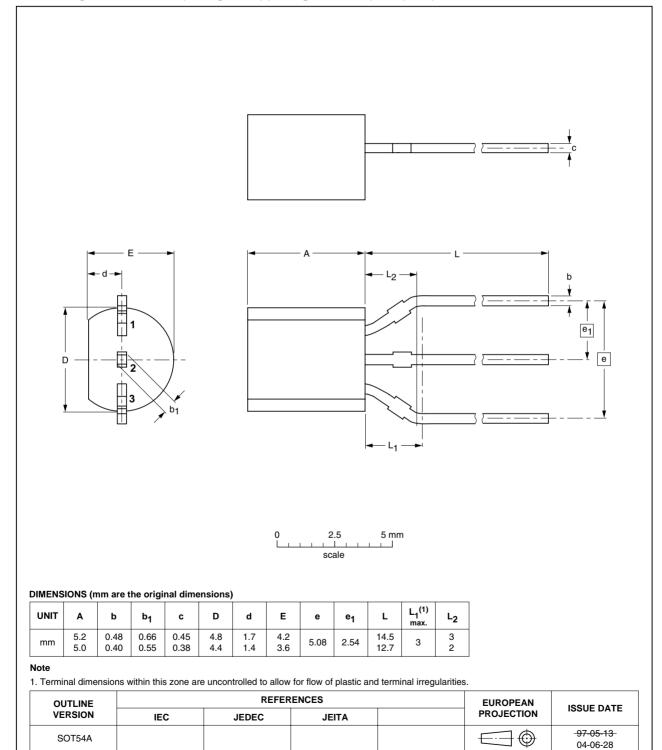


Fig 16. Package outline SOT54A

BC807_BC807W_BC327_6

Plastic single-ended leaded (through hole) package; 3 leads (on-circle)

SOT54 variant

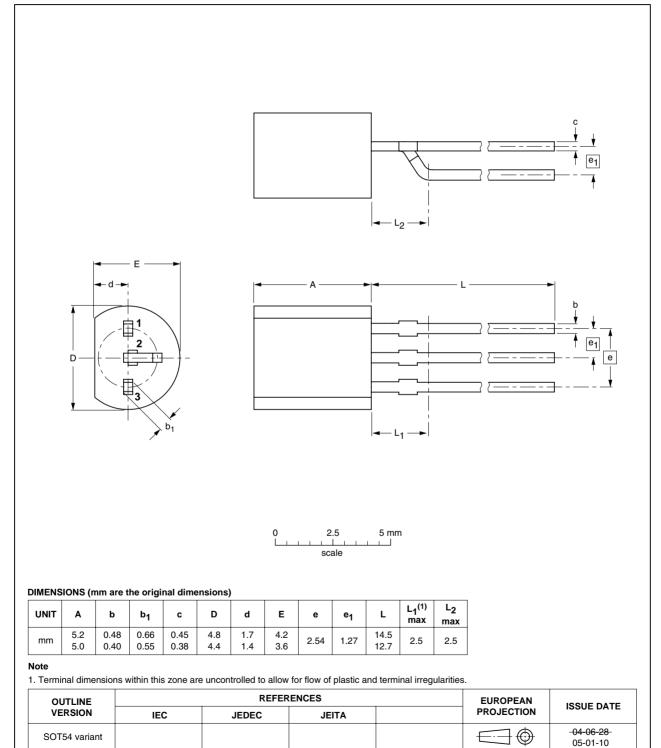


Fig 17. Package outline SOT54 variant

BC807_BC807W_BC327_6

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Packing information

Table 9. **Packing methods**

Product data sheet

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description | Packing | Packing quantity | | |
|-------------|----------------|---------------------------------|---------|------------------|-------|--|
| | | | 3000 | 5000 | 10000 | |
| BC807 | SOT23 | 4 mm pitch, 8 mm tape and reel | -215 | - | -235 | |
| BC807W | SOT323 | 4 mm pitch, 8 mm tape and reel | -115 | - | -135 | |
| BC327 | SOT54 | bulk, straight leads | - | -412 | - | |
| BC327 | SOT54A | tape and reel, wide pitch | - | - | -116 | |
| BC327 | SOT54A | tape ammopack, wide pitch | - | - | -126 | |
| BC327 | SOT 54 variant | bulk, delta pinning (on-circle) | - | -112 | - | |

^[1] For further information and the availability of packing methods, see Section 12.

10. Revision history

Table 10. Revision history

| Table 101 Horioletti | | | | |
|--------------------------|--|--|---|-------------------------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| BC807_BC807W_ BC327_6 | 20091117 | Product data sheet | - | BC807_BC807W_ BC327_5 |
| Modifications: | including net content. Table 3 "Pinr Figure 13 "P | eet was changed to reflect to which legal definitions and disclassing. The legal definitions and disclassing. The legal definition is a legal definition of the legal definitions and disclassing definitions are definitions and disclassing definitions are definitionally definitions and disclassing definitions are definitionally definitions. | aimers. No changes we 236AB)": updated | |
| BC807_BC807W_ BC327_5 | 20050221 | Product data sheet | CPCN200302007F CPCN200405006F | BC807_4; BC807W_3; BC327_3 |
| BC807_4 | 20040116 | Product specification | - | BC807_3 |
| BC807W_3 | 19990518 | Product specification | - | BC807W_808W_CNV_ |
| BC327_3 | 19990415 | Product specification | - | BC327_2 |
| | | | | |

11. Legal information

11.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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